Overview

HP ProBook 635 Aero G8 Notebook PC



- 1. Ambient Light Sensor (Optional)
- 2. Internal Microphones (2)
- 3. Webcam LED (Optional)
- 4. Camera Shutter (Only available with webcam)
- 5. HD and IR Camera (Optional)

Left

- 6. IR Camera LED (Optional)
- 7. Glass Clickpad
- 8. Audio Combo Jack
- 9. SuperSpeed USB Type-A 5Gbps signaling rate Port
- 10. SuperSpeed USB Type-A 5Gbps signaling rate Charging Port
- 11 Nano Security Lock Slot (Lock sold separately)



Overview



Right

- 1. Power Button Key
- 2. Power Connector
- 3. HDMI Port (Cable not included)
- SuperSpeed USB Type-C[®] 10Gbps signaling rate (Power delivery, DisplayPort[™] 1.4)
- 5. Nano SIM Card Slot¹
- 6. Touch Fingerprint Sensor (Select models)
- 1. All units have a SIM card tray but units that do not support WWAN are shipped with a non-removable SIM slot plug

QuickSpecs

Overview

At a Glance

- An ultralight sub-1 Kg laptop all-metal design¹
- Choice of AMD Ryzen™ 5000 Series Mobile Processors.
- Enables AMD Memory Guard to help defend against cold boot attacks with real-time encryption and decryption of system's memory with AMD Ryzen PRO Processors.
- Preinstalled with Windows 10 versions or FreeDOS
- Choice of 13.3" (33.8 cm) diagonal ultra-wide viewing angle FHD and privacy panel option
- Supports wireless options for connectivity on the go including gigabit-speed Wi-Fi® 6 and CAT9 4G/LTE WWAN
- Fast and upgradeable dual channel DDR4 SODIMM memory up to 32 GB
- Choice of solid state drives up to 1 TB
- Features quiet and responsive HP Premium Keyboard with the HP Programmable key and backlit options
- Multi-layered security with HP Sure Start Gen7, HP Privacy Camera, HP Sure View Reflect, HP Sure Recover, HP Sure Run, HP Sure Sense, HP Sure Click, and Touch Fingerprint sensor
- Supports fast charging (50% in 30 minutes) with no impact on battery recharge cycles
- Battery life up to 15 hours and 30 minutes (42Whr) and up to 20 hours (53 Whr) (AMD Ryzen[™] 5000 Series Mobile Processors and 3-cell 53 Wh battery)
- Designed to support optional HP docking options including the HP Universal Dock G5 (Docks sold separately)
- Undergoes MIL-STD 810H tests ²
- 1. 250 nit panel, HP Sure View Reflect, multiple SODIMMs, WWAN, 53 Wh battery, and backlit keyboard not available on configurations starting at less than 1kg.
- MIL STD 810H testing is not intended to demonstrate fitness for U.S. Department of Defense contract requirements or for military use. Test results are not a guarantee of future performance under these test conditions. Accidental damage requires an optional HP Accidental Damage Protection Care Pack.

NOTE: See important legal disclosures for all listed specs in their respective features sections.



PRODUCT NAME

HP ProBook 635 Aero G8 Notebook PC

OPERATING SYSTEMS

Preinstalled

Windows 10 Pro 64 – HP recommends Windows 10 Pro¹ Windows 10 Pro 64 (National Academic only)² Windows 10 Home 64¹ Windows 10 Home Single Language 64¹ Windows 10 Pro (Windows 10 Enterprise available with a Volume Licensing Agreement)¹ Windows 10 Enterprise 64¹ (Web support)

FreeDOS

1. Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated, which is always enabled. ISP fees may apply and additional requirements may apply over time for updates. See http://www.windows.com.

2. Some devices for academic use will automatically be updated to Windows 10 Pro Education with the Windows 10 Anniversary Update. Features vary; see https://aka.ms/ProEducation for Windows 10 Pro Education feature information. Note: HP tested Windows 10, 20H2, 2004(20H1), 1909(19H2) on this platform. For testing information on newer versions of Windows 10, please see https://support.hp.com/document/c05195282.

Supported Versions

HP tested Windows 10, version 1909 on this platform. For testing information on newer versions of Windows 10, please see https://support.hp.com/document/c05195282

PROCESSORS

AMD Ryzen[™] 7 PRO 5850U with Radeon[™] Graphics (3.2 GHz base clock, up to 4.4 GHz max boost clock, 16 MB L3 cache, 8 cores) ^{3,4,5}

AMD Ryzen[™] 5 PRO 5650U with Radeon[™] Graphics (2.3 GHz base clock, up to 4.2 GHz max boost clock, 16 MB L3 cache, 6 cores)^{3,4,5}

AMD Ryzen[™] 7 5800U with Radeon[™] Graphics (1.9 GHz base clock, up to 4.4 GHz max boost clock, 16 MB L3 cache, 8 cores)^{3,4,5}

AMD Ryzen[™] 5 5600U with Radeon[™] Graphics (2.3 GHz base clock, up to 4.2 GHz max boost clock, 16 MB L3 cache, 6 cores) ^{3,4,5}

AMD Ryzen[™] 3 5400U with Radeon[™] Graphics (2.6 GHz base clock, up to 4.0 GHz max boost clock, 8 MB L3 cache, 4 cores) ^{3,4,5}

Processors Family

AMD Ryzen[™] 5000 Series Mobile Processors⁶

3. Processor speed denotes maximum performance mode; processors will run at lower speeds in battery optimization mode.



4. Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. AMD's numbering is not a measurement of clock speed.

5. AMD Max Burst frequency performance varies depending on hardware, software and overall system configuration.

6. In accordance with Microsoft's support policy, HP does not support the Windows 8 or Windows 7 operating system on products configured with Intel and AMD 7th generation and forward processors or provide any Windows 8 or Windows 7 drivers on http://www.support.hp.com.

CHIPSET

Chipset is integrated with processor

GRAPHICS

Integrated AMD Radeon™ Graphics⁷

Supports

Support HD decode, DX12, HDMI2.0 7. FHD/HD content required to view FHD/HD images.

DISPLAY

Non-Touch

33ñ.8 cm (13.3") diagonal FHD UWVA eDP anti-glare WLED-backlit bent, 250 nits, 45% NTSC (1920 x 1080) ^{7,9} 33.8 cm (13.3") diagonal FHD UWVA eDP anti-glare WLED-backlit bent, 250 nits, 45% NTSC for HD camera (1920 x 1080) ^{7,9}

33.8 cm (13.3") diagonal FHD UWVA eDP anti-glare WLED-backlit bent, 250 nits, 45% NTSC for HD + IR camera (1920 x 1080) ^{7,9}

33.8 cm (13.3") diagonal FHD UWVA eDP+PSR anti-glare, low power bent with Ambient Light Sensor, 400 nits, 100%sRGB for HD + IR camera (1920 x 1080)^{7,9}

33.8 cm (13.3") diagonal FHD UWVA eDP+PSR anti-glare, low power bent with Ambient Light Sensor, 400 nits, 100%sRGB for HD + IR camera for WWAN (1920 x 1080)^{7,9}

33.8 cm (13.3") diagonal FHD UWVA eDP + PSR anti-glare WLED-backlit bent, 1000 nits with HP Sure View Reflect Integrated Privacy Screen, 72% NTSC with Ambient Light Sensor and HD + IR camera (1920 x 1080)^{7,9,10}

33.8 cm (13.3") diagonal FHD UWVA eDP + PSR anti-glare WLED-backlit bent, 1000 nits with HP Sure View Reflect Integrated Privacy Screen, 72% NTSC with Ambient Light Sensor and HD + IR camera for WWAN (1920 x 1080) ^{7,9,10}

HDMI⁸

Support resolution up to 4k @ 60Hz

7. FHD/HD content required to view FHD/HD images.

- 8. HDMI cable sold separately.
- 9. Resolutions are dependent upon monitor capability, and resolution and color depth settings.



10. HP Sure View integrated privacy screen is an optional feature that must be configured at purchase and is designed to function in landscape orientation.

NOTE: Actual brightness will be lower with touchscreen or Sure View.

STORAGE AND DRIVES

Primary M.2 Storage

1 TB PCIe[®] Gen3 x4 NVMe[™] TLC Solid State Drive¹¹ 512 GB PCIe[®] Gen3x4 NVMe[™] TLC Solid State Drive¹¹ 512 GB PCIe[®] NVMe[™] Value Solid State Drive¹¹ 256 GB PCIe[®] Gen3x4 NVMe[™] TLC Solid State Drive¹¹ 256 GB PCIe[®] NVMe[™] Value Solid State Drive¹¹ 128 GB M.2 PCIe TLC Solid State Drive¹¹

For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows
 is reserved for system recovery software.

MEMORY

Maximum Storage 32 GB DDR4-3200 SDRAM

Memory

32 GB DDR4-3200 SDRAM (2 x 16 GB) ¹² 16 GB DDR4-3200 SDRAM (1 x 16 GB) ¹² 16 GB DDR4-3200 SDRAM (2 x 8 GB) ¹² 8 GB DDR4-3200 SDRAM (1 x 8 GB) ¹² 8 GB DDR4-3200 SDRAM (2 x 4 GB) ¹² 4 GB DDR4-3200 SDRAM (1 x 4 GB) ¹²

Memory Slots

2 SODIMM Both slots are accessible/upgradeable by IT or self-maintainers only DDR4 SODIMMS, system runs at 3200 Supports Dual Channel Memory

12. Due to the non-industry standard nature of some third-party memory modules, we recommend HP branded memory to ensure compatibility. If you mix memory speeds, the system will perform at the lower memory speed.



NETWORKING/COMMUNICATIONS

WLAN

Intel[®] AX200 Wi-Fi 6 (2x2) and Bluetooth[®] 5 Combo, non-vPro[®] ¹³ Realtek RTL8822CE 802.11ac (2x2) and Bluetooth[®] 5 Combo¹³

WWAN

Intel[®] XMM[™] 7360 LTE-Advanced Cat 9 ¹⁴

13. Wireless access point and internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 6 is backwards compatible with prior 802.11 specs. The specifications for Wi-Fi 6 (802.11ax) are draft and are not final. If the final specifications differ from the draft specifications, it may affect the ability of the notebook to communicate with other 802.11ax devices. Wi-Fi 5 (802.11 ac) is backwards compatible with prior 802.11 specs. 14. WWAN module is an optional feature, requires factory configuration and requires separately purchased service contract. Check with service provider for coverage and availability in your area. Connection speeds will vary due to location, environment, network conditions, and other factors. 4G LTE not available on all products, in all regions.

AUDIO/MULTIMEDIA

Audio

Integrated microphone (Dual Array) 2 Integrated Stereo Speakers

Speaker Power

2W/4ohm Per speaker

Camera

720p HD camera ^{7,43} 720p HD+IR camera ^{7,43,15}

Sensors Ambient light sensor (select models only) Hall Sensor

7. FHD/HD content required to view FHD/HD images.

43. Sold separately or as an optional feature.

15. Internet access required.



KEYBOARDS/POINTING DEVICES/BUTTONS & FUNCTION KEYS

Keyboard

HP Premium Keyboard, spill resistant, Durakeys Backlit keyboard ¹⁶

Pointing Device

Clickpad with multi-touch gestures enabled, taps enabled as default Microsoft Precision Touchpad Default Gestures Support

Function Keys

F1 - Display Switching F2 - Blank or SureView On/Off (with LED) F3 - Brightness Down F4 - Brightness Up F5 - Audio Mute (with LED) F6 - Volume Down F7 - Volume Up F8 - Mic Mute (with LED) F9 - Blank or Backlit Toggle F10 - Insert F11 - Airplane Mode F12 - HP Programmable Key Print Screen Power Button (with LED)

Hiden Function Keys

Fn+R - Break Fn+S - Sys Rq Fn+C - Scroll Lock Fn+E - Insert Fn+W - Pause

16. Backlit keyboard is an optional feature.



SOFTWARE AND SECURITY

HP BIOSphere Gen6¹⁷ HP Drive Lock & Automatic Drive Lock BIOS Update via Network HP Secure Erase¹⁸ Absolute Persistence Module¹⁹ HP LAN-Wireless Protection USB enable/disable (via BIOS)

Software

HP Connection Optimizer ²⁰ HP Hotkey Support myHP HP Support Assistant ²¹ HP Noise Cancellation Software Touchpoint Customizer for Commercial HP QuickDrop²² HP Notifications HP Privacy Settings HP Wireless Button Driver HP Power Manager Microsoft Defender Buy Office (sold separately) HP Smart Support ⁴⁶

Manageability Features

HP Driver Packs (download) ²³ HP Manageability Integration Kit for Microsoft Center Configuration manager Gen4 (download) ²⁴ HP Client Catalog (download) HP Client Management Script Library (download) HP Image Assistant (download)

Security Management

HP Wolf Pro Security Edition ²⁵ HP Sure Click ²⁶ HP Sure Sense ²⁷ HP Sure Start Gen7 ²⁸ HP Sure Admin ²⁹ HP Sure Recover Gen4 ³⁰ HP Sure Run Gen4 ³¹ HP Fingerprint Sensor ³² TPM 2.0 Embedded Security Chip (Common Criteria EAL4+ Certified) (FIPS 140-2 Level 2 Certified) Secured-core PC Enable³³

Is the BIOS on this notebook ISO/IEC 19678:2015 (formerly NIST 800-147) compliant?: Yes

UEFI version: 2.7 Class: Class 3

17. HP BIOSphere Gen6 requires Windows 10 and is available on select HP Pro and Elite PCs. Features may vary depending on the platform and configurations.



18. HP Secure Erase For the methods outlined in the National Institute of Standards and Technology Special Publication 800-88 "Clear" sanitation method. HP Secure Erase does not support platforms with Intel[®] Optane[™].

19. Absolute firmware module is shipped turned off and can only be activated with the purchase a license subscription and full activation of the software agent. License subscriptions can be purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside the U.S. Certain conditions apply. For full details visit: https://www.absolute.com/about/legal/agreements/absolute/ 20. HP Connection Optimizer requires Windows 10.

21. HP Support Assistant requires Windows and Internet access.

22. HP Quick Drop requires Internet access and Windows 10 PC preinstalled with HP QuickDrop app and either an Android device (phone or tablet) running Android 7 or higher with the Android HP QuickDrop app, and /or an iOS device (phone or tablet) running iOS 12 or higher with the iOS HP QuickDrop app.

23. HP Driver Packs not preinstalled, however available for download at

http://www.hp.com/go/clientmanagement.

24. HP Manageability Integration Kit can be downloaded from http://www.hp.com/go/clientmanagement.

25. HP Wolf Pro Security Edition (including HP Sure Click Pro and HP Sure Sense Pro) is available preloaded on select SKUs and, depending on the HP product purchased, includes a paid 1-year or 3-year license. The HP Wolf Pro Security Edition software is licensed under the license terms of the HP Wolf Security Software - End-User license Agreement (EULA) that can be found at: https://support.hp.com/us-en/document/ish_3875769-3873014-16 as that EULA is modified by the following: "7. Term. Unless otherwise terminated earlier pursuant to the terms contained in this EULA, the license for the HP Wolf Pro Security Edition (HP Sure Sense Pro and HP Sure Click Pro) is effective upon activation and will continue for either a twelve (12) month or thirty-six (36) month license term ("Initial Term"). At the end of the Initial Term you may either (a) purchase a renewal license for the HP Wolf Pro Security Edition from HP.com, HP Sales or an HP Channel Partner, or (b) continue using the standard versions of HP Sure Click and HP Sure Sense at no additional cost with no future software updates or HP Support.

26. HP Sure Click requires Windows 10. See https://bit.ly/2PrLT6A_SureClick for complete details

27. HP Sure Sense is available on select HP PCs and is not available with Windows10 Home.

28. HP Sure Start Gen7 is available on select HP PCs and requires Windows 10

29. HP Sure Admin requires Windows 10, HP BIOS, HP Manageability Integration Kit from

http://www.hp.com/go/clientmanagement and HP Sure Admin Local Access Authenticator smartphone app from the Android or Apple store.

30. HP Sure Recover Gen4 is available on select HP PCs and requires Windows 10 and an open network connection. You must back up important files, data, photos, videos, etc. before using HP Sure Recover to avoid loss of data. Network based recovery using Wi-Fi is only available on PCs with Intel Wi-Fi Module.

31. HP Sure Run Gen4 is available on select HP PCs and requires Windows 10

32. HP Fingerprint sensor is an optional feature that must be configured at purchase.

33. Secured-core PC Enable Requires an Intel[®] vPro[®], AMD Ryzen[™] Pro processor or Qualcomm[®] processor with SD850 or higher and requires 8 GB or more system memory. Secured-core PC functionality can be enabled from the factory.

46. HP Smart Support is available to commercial customers through your HP Service Representative and HP Factory Configuration Services; or it can be downloaded at: http://www.hp.com/smart-support. HP Smart Support automatically collects the telemetry necessary upon initial boot of the product to deliver device-level configuration data and health insights.

POWER



Power Supply

HP Smart 65 W External AC power adapter ³⁴ HP Smart 65 W EM External AC power adapter ³⁴ HP Smart 65 W USB Type-C adapter ³⁴ HP Smart 45 W External AC power adapter ³⁴ HP Smart 45 W External AC power adapter, 2-prong (Japan only) ³⁴ HP Smart 45 W USB Type-C adapter ³⁴

Power Cord 3-wire plug – 1.0m ³⁴

 $2-\text{wire plug} - 1.0\text{m}^{34}$

Primary Battery

HP Long Life 3-cell, 42 Wh Li-ion ^{35,44} HP Long Life 3-cell, 53 Wh Li-ion ^{35,44} Support HP Fast Charge (Up to 50% in 30 minutes with 65W AC Adapter) ³⁶

Battery life

MM18 Battery life 42 Wh battery: Up to 15 hours 30 minutes⁴⁵ 53 Wh battery: Up to 20 hours⁴⁵

Battery Weight

42W battery: 0.17 kg (0.37 lb) 53W battery: 0.21 kg (0.45 lb)

34. Availability may vary by country.

35. Battery is internal and not replaceable by customer. Serviceable by warranty.

36. Recharges your battery up to 50% within 30 minutes when the system is off or in standby mode. Power adapter with a minimum capacity of 65 watts is required. After charging has reached 50% capacity, charging will return to normal. Charging time may vary +/-10% due to System tolerance.

44. Actual battery Watt-hours (Wh) will vary from design capacity. Battery capacity will naturally decrease with shelf life, time, usage, environment, temperature, system configuration, loaded apps, features, power management settings and other factors.

45. Windows 10 MM18 battery life will vary depending on various factors including product model, configuration, loaded applications, features, use, wireless functionality, and power management settings. The maximum capacity of the battery will naturally decrease with time and usage. See http://www.bapco.com for additional details.



WEIGHTS & DIMENSIONS

Product Weight Starting at 2.2 lb ³⁷ Starting at 0.99 kg ³⁷

Product Dimensions (w x d x h) 400 nits panels: 30.76 x 20.45 x 1.79 cm 12.11 x 8.05 x 0.71 in

1000 nits panels 30.76 x 20.45 x 1.79 cm 12.11 x 8.05 x 0.71 in

250 nits panels: 30.76 x 20.45 x 1.92 cm 12.11 x 8.05 x 0.756 in

37. Weight will vary by configuration.

PORTS/SLOTS

Ports

SuperSpeed USB Type-C[®] 10Gbps signaling rate (Power delivery, DisplayPort[™] 1.4)
 SuperSpeed USB Type-A 5Gbps signaling rate (1 charging port)
 HDMI 2.0 ³⁸
 Headphone/microphone combo
 AC power
 Nano SIM card slot ³⁹

38. HDMI cable sold separately.39. SIM slot is not user accessible without WWAN configuration.



SERVICE AND SUPPORT

1-year and 3-year limited warranties and 90-day software limited warranty options depending on country. Batteries have a default one-year limited warranty except for HP Long Life batteries which will follow the one- or threeyear warranty of the platform. Refer to http://www.hp.com/support/batterywarranty/ for additional battery information. On-site service and extended coverage is also available. HP Care Pack Services are optional extended service contracts that go beyond the standard limited warranties. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: http://www.hp.com/go/cpc.⁴⁰

40. HP Care Packs are sold separately. Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. For details, visit http://www.hp.com/go/cpc. HP services are governed by the applicable HP terms and conditions of service provided or indicated to Customer at the time of purchase. Customer may have additional statutory rights according to applicable local laws, and such rights are not in any way affected by the HP terms and conditions of service or the HP Limited Warranty provided with your HP Product.



SYSTEM UNIT

Stand-Alone Power Requirements (AC Power)	
Nominal Operating Voltage	19 V
Average Operating Power	2.82W
Integrated graphics	6.78W
Discrete Graphics	N/A
Max Operating Power	UMA < 45W
Temperature	
Operating	41° to 95° F (5° to 35° C)
Non-operating	-4° to 140° F (-20° to 60° C)
Relative Humidity	
Operating	10% to 90%, non-condensing
Non-operating	5% to 95%, 101.6° F (38.7° C) maximum wet bulb temperature
Shock	
Operating	40 G, 2 ms, half-sine
Non-operating	200 G, 2 ms, half-sine
Random Vibration	
Operating	0.75 grms
Non-operating	1.50 grms
Altitude (unpressurized)	
Operating	-50 to 10,000 ft (-15.24 to 3,048 m)
Non-operating	-50 to 40,000 ft (-15.24 to 12,192 m)
Planned Industry Standard Certifications	
UL	Yes
CSA	Yes
FCC Compliance	Yes
ENERGY STAR®	ENERGY STAR 8.0 ⁴¹
EPEAT [®]	EPEAT [®] Gold in United States ⁴²
ICES	Yes
Australia /	Yes
NZ A – Tick Compliance	Yes
CCC	Yes
Japan VCCI Compliance KC	Yes Yes
BSMI	Yes
CE Marketing Compliance	Yes
BNCI or BELUS	Yes
CIT	Yes
GOST	Yes
Saudi Arabian Compliance (ICCP)	Yes
SABS	Yes

41. Configurations of the HP ProBook 635 Aero G8 that are ENERGY STAR[®] qualified are identified as ProBook 635 Aero G8 ENERGY STAR on HP websites and on http://www.energystar.gov.
42. Based on US EPEAT[®] registration according to IEEE 1680.1-2018 EPEAT[®]. EPEAT[®] status varies by country. Visit http://www.epeat.net for more information.



DISPLAYS

NOTE: All specifications represent the typical specifications provided by hp's component manufacturers; actual performance may vary either higher or lower.

1. Actual brightness will be lower with touchscreen or Sure View.

Panel LCD 13.3 inch FHD (1920 x 1080) Anti-Glare WLED UWVA 45percent cg 250nits eDP 1.2 w/o PSR	Outline Dimensions (W x H x D)	300.56 x 177.77 mm (max) (FPC folding included)
	Active Area	293.76 x 165.24 mm
	Weight	260 g (max)
bent NWBZ	Diagonal Size	13.3 inch
	Thickness	3.0 mm/ 5.0 mm (PCB) (max)
	Interface	eDP 1.2 (2lane)
	Surface Treatment	Anti-Glare
	Touch Enabled	No
	Contrast Ratio	600:1
	Refresh Rate	60 Hz
	Brightness	250 nits
	Pixel Resolution	1920 x 1080 (FHD)
	Format	RGB Stripe
	Backlight	LED
	Color Gamut Coverage	NTSC 45%
	Color Depth	6 bits
	Viewing Angle	UWVA 85/85/85/85
Denal I CD 12 2 in th FUD		
Panel LCD 13.3 inch FHD (1920x1080) Anti-Glare	Outline Dimensions (W x H x D)	299.06 x 176.54 mm (max) (FPC folding included)
WLED UWVA sRGB	Active Area	293.76 x 165.24 mm
100percent cg 400nits eDP	Weight Diagonal Sizo	175 g (max)
1.4+PSR2 bent LP NB2Y	Diagonal Size Thickness	13.3 inch
	Interface	2.0 mm / 3.8 mm (PCB) (max)
	Surface Treatment	eDP 1.4 w/ PSRII (2 lane)
	Touch Enabled	Anti-Glare
	Contrast Ratio	No
	Refresh Rate	1500:1
		60 Hz
	Brightness	400 nits
	Brightness Pixel Resolution	400 nits 1920 x 1080 (FHD)
	Brightness Pixel Resolution Format	400 nits 1920 x 1080 (FHD) RGB Stripe
	Brightness Pixel Resolution Format Backlight	400 nits 1920 x 1080 (FHD) RGB Stripe LED
	Brightness Pixel Resolution Format Backlight Color Gamut Coverage	400 nits 1920 x 1080 (FHD) RGB Stripe LED sRGB 100%
	Brightness Pixel Resolution Format Backlight Color Gamut Coverage Color Depth	400 nits 1920 x 1080 (FHD) RGB Stripe LED sRGB 100% 8 bits
	Brightness Pixel Resolution Format Backlight Color Gamut Coverage	400 nits 1920 x 1080 (FHD) RGB Stripe LED sRGB 100%



Panel LCD 13.3inch FHD
(1920x1080) Anti-Glare
WLED UWVA 72percent cg
1000nits eDP 1.4+PSR
PrivacyG4

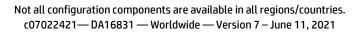
Outline Dimensions (W x H x D)	299.06 x 176.54 mm (max)
Active Area	293.76 x 165.24 mm
Weight	220 g (max)
Diagonal Size	13.3 inch
Thickness	3.9 mm (max)
Interface	eDP 1.4 + PSR (4 lane)
Surface Treatment	Anti-glare (AG)
Touch Enabled	No
Contrast Ratio	1500:1
Refresh Rate	60 Hz
Brightness	1000 nits
Pixel Resolution	1920 x 1080 (FHD)
Format	RGB
Backlight	LED
Color Gamut Coverage	NTSC 72%
Color Depth	8 bits
Viewing Angle	UWVA 85/85/85/85

STORAGE AND DRIVES¹

1 For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10) is reserved for system recovery software.

SSD 128GB 2280 M2 SATA-3 TLC	-3 Form Factor	M.2 2280	
	Capacity	128 GB	
	NAND Type	TLC	
	Height	0.09 in (2.3 mm)	
	Width	0.87 in (22 mm)	
	Weight	0.02 lb (10 g)	
	Interface	ATA-8, SATA 3.0	
	Maximum Sequential Read	550 ~ 560 MB/s	
	Maximum Sequential Write	380 ~ 530 MB/s	
	Logical Blocks	250,069,680	
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]	
	Features	ATA Security; DIPM; TRIM; DEVSLP	
SSD 1TB 2280 PCIe-3x4 NVMe Three Laver Cell	Form Factor	M.2 2280	
NVMe Three Layer Cell	Capacity	1 TB	
single-sided	NAND Type	TLC	
	Height	0.09 in (2.3 mm)	
	Width	0.87 in (22 mm)	
	Weight	0.02 lb (10 g)	
	Interface	PCIe NVMe Gen3X4	
	Maximum Sequential Read	3100 ~ 3500 MB/s	
	Maximum Sequential Write	2770 ~ 3037 MB/s	
	Logical Blocks	2,000,409,264	
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]	
	Features	ATA Security; TRIM; L1.2	

SSD 256GB 2280 PCIe NVMe	Form Factor	M.2 2280
Value	Capacity	256 GB
	NAND Type	Value
	Height	0.09 in (2.3 mm)
	Width	0.87 in (22 mm)
	Weight	0.02 lb (10 g)
	Interface	PCIe NVMe Gen3
	Maximum Sequential Read	2100 ~ 2200 MB/s
	Maximum Sequential Write	900 ~ 1400 MB/s
	Logical Blocks	500,118,192
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
	Features	ATA Security (optional); TRIM; L1.2
SSD 512GB 2280 PCIe NVMe	Form Factor	M.2 2280
Value	Capacity	512 GB
	NAND Type	Value
	Height	0.09 in (2.3 mm)
	Width	0.87 in (22 mm)
	Weight	0.02 lb (10 g)
	Interface	PCIe NVMe Gen3
	Maximum Sequential Read	2200 ~ 2300 MB/s
	Maximum Sequential Write	1000 ~ 1600 MB/s
	Logical Blocks	1,000,215,215
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
	Features	ATA Security (optional); TRIM; L1.2
SSD 256GB 2280 M2 PCIe-	Form Factor	M.2 2280
3x4 SS NVMe TLC	Capacity	256 GB
	NAND Type	TLC
	Height	0.09 in (2.3 mm)
	Width	0.87 in (22 mm)
	Interface	PCIe NVMe Gen3X4
	Maximum Sequential Read	2800 ~ 3500 MB/s
	Maximum Sequential Write	1400 ~ 2200 MB/s
	Logical Blocks	500,118,192
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
	Features	ATA Security; TRIM; L1.2



SSD 512GB 2280 M2 PCIe	2
3x4 SS NVMe TLC	

Form Factor	M.2 2280
Capacity	512 GB
NAND Type	TLC
Height	0.09 in (2.3 mm)
Width	0.87 in (22 mm)
Weight	0.02 lb (10 g)
Interface	PCIe NVMe Gen3X4
Maximum Sequential Read	3100 ~ 3500 MB/s
Maximum Sequential Write	2400 ~ 2956 MB/s
Logical Blocks	1,000,215,215
Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
Features	ATA Security; TRIM; L1.2



NETWORKING / COMMUNICATIONS

Intel® Wi-Fi 6 ¹ AX200 + Bluetooth® 5 (802.11ax 2x2, non-vPro®, supporting gigabit data rate) non-vPro® ⁵	Wireless LAN Standards	IEEE 802.11a IEEE 802.11b IEEE 802.11g IEEE 802.11n IEEE 802.11ac IEEE 802.11ax IEEE 802.11d IEEE 802.11e IEEE 802.11h IEEE 802.11h IEEE 802.11i IEEE 802.11r IEEE 802.11r IEEE 802.11v
	Interoperability	Features Wi-Fi 6 technology
	Frequency Band	802.11b/g/n/ax •2.402 – 2.482 GHz 802.11a/n/ac/ax •4.9 – 4.95 GHz (Japan) •5.15 – 5.25 GHz •5.25 – 5.35 GHz •5.47 – 5.725 GHz •5.825 – 5.850 GHz
	Data Rates	 •802.11b: 1, 2, 5.5, 11 Mbps •802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11a: MCS 0 ~ MCS 15, (20MHz, and 40MHz) •802.11ac : MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, ,80MHz & 160MHz) •802.11ax : MCS0 ~ MCS11, (1SS and 2SS) (20MHz, 40MHz, ,80MHz & 160MHz)
	Modulation	Direct Sequence Spread Spectrum OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM, 1024QAM
	Security ³	 IEEE compliant 64 / 128 bit WEP encryption for a/b/g mode only AES-CCMP: 128 bit in hardware 802.1x authentication WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES. WPA2 certification WPA3 certification IEEE 802.11i WAPI
	Network Architecture Models	Ad-hoc (Peer to Peer)
	Roaming	Infrastructure (Access Point Required)
	Output Power ²	IEEE 802.11 compliant roaming between access points • 802.11b : +18.5dBm minimum • 802.11g : +17.5dBm minimum • 802.11a : +18.5dBm minimum



QuickSpecs

Technical Specifications

	 802.11n HT20(2.4GHz) 802.11n HT40(2.4GHz) 802.11n HT20(5GHz) : 802.11n HT40(5GHz) : 802.11ac VHT80(5GHz) 802.11ac VHT160(5GHz) 802.11ax HT40(2.4GHz) 802.11ax VHT160(5GHz) 	: +14.5dBm minimum +15.5dBm minimum +14.5dBm minimum) : +11.5dBm minimum z) : +11.5dBm minimum z) : +10dBm minimum	
Power Consumption	 Transmit mode: 2.0 W Receive mode:1.6 W Idle mode (PSP) 180 m Idle mode: 50 mW (WL Connected Standby/Mo Radio disabled: 8 mW 	AN unassociated)	
Power Management	ACPI and PCI Express compliant power management 802.11 compliant power saving mode		
Receiver Sensitivity ⁴	 802.11b, 1Mbps: -93.5dBm maximum 802.11b, 11Mbps: -84dBm maximum 802.11a/g, 6Mbps: -86dBm maximum 802.11a/g, 54Mbps: -72dBm maximum 802.11n, MCS07: -67dBm maximum 802.11n, MCS15: -64dBm maximum 802.11ac, MCS0: -84dBm maximum 802.11ac, MCS9: -59dBm maximum 802.11ax, MCS11(HT40): -59dBm maximum 802.11ax, MCS11(VHT160): -58.5dBm maximum 		
Antenna type	enclosure Two embedded dual bar	with spatial diversity, mounted in the display od 2.4/5 GHz antennas are provided to the card to nmunications and Bluetooth communications	
Form Factor	PCI-Express M.2 MiniCard		
Dimensions	1. Type 2230: 2.3 x 22.0 x 30.0 mm 2. Type 1216: 1.67 x 12.0 x 16.0 mm		
Weight	1. Туре 2230: 2.8 g 2. Туре 126: 1.3 g		
Operating Voltage	3.3v +/- 9%		
Temperature	Operating Non-operating	14° to 158° F (–10° to 70° C) –40° to 176° F (–40° to 80° C)	
Humidity	Operating Non-operating	10% to 90% (non-condensing) 5% to 95% (non-condensing)	
Altitude	Operating Non-operating	0 to 10,000 ft (3,048 m) 0 to 50,000 ft (15,240 m)	
LED Activity	LED Amber – Radio OFF LED Off – Radio ON		

HP Integrated Module with Bluetooth 4.0/4.1/4.2/5.0/5.1 Wireless Technology



Bluetooth Specification	4.0/4.1/4.2/5.0/5.1 Compliant	
Frequency Band	2402 to 2480 MHz	
Number of Available Channels	Legacy: 0~79 (1 MHz/CH) BLE: 0~39 (2 MHz/CH)	
Signaling Data Rate	Legacy: 3 Mbps signaling data rate ⁶ 2.17 Mbps BLE: 1 Mbps signaling data rate ¹ 0.2 Mbps 6. Actual throughput may vary.	
	Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice channels Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)	
Transmit Power	The Bluetooth component shall operate as a Class II Bluetooth device with a maximum transmit power of + 9.5 dBm for BR and EDR.	

1. Wireless access point and internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 6 is backwards compatible with prior 802.11 specs. The specifications for Wi-Fi 6 (802.11ax) are draft and are not final. If the final specifications differ from the draft specifications, it may affect the ability of the notebook to communicate with other 802.11ax

devices. Only available in countries where 802.11ax is supported.

2. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.

3. Check latest software/driver release for updates on supported security features.

4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

5. Wi-Fi 5 or 6 is designed to support gigabit data rate when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 80MHz and higher channels.



Realtek RTL8822CE 802.11ac 2x2 Wi-Fi +	Wireless LAN Standards	IEEE 802.11a
Bluetooth5 ¹		IEEE 802.11b
Blactoollig		IEEE 802.11g
		IEEE 802.11n
		IEEE 802.11ac IEEE 802.11d
		IEEE 802.110 IEEE 802.11e
		IEEE 802.11h
		IEEE 802.11i
		IEEE 802.11k
		IEEE 802.11r
		IEEE 802.11v
	Interoperability	Wi-Fi [®] CERTIFIED modules
	Frequency Band	• 802.11b/g/n
		2.402 – 2.482 GHz
		• 802.11a/n/ac
		4.9 – 4.95 GHz (Japan)
		5.15 – 5.25 GHz
		5.25 – 5.35 GHz
		5.47 – 5.725 GHz
		5.825 – 5.850 GHz
	Data Rates	• 802.11b: 1, 2, 5.5, 11 Mbps
		• 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
		• 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
		• 802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)
		• 802.11ac : MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz & 80MHz)
	Modulation	Direct Sequence Spread Spectrum
		BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM
	Security ³	 IEEE compliant 64 / 128 bit WEP encryption for a/b/g mode only
		AES-CCMP: 128 bit in hardware
		802.1x authentication
		WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.
		WPA2 certification WPA3 certification
		• IEEE 802.11i
		• WAPI
	Network Architecture	Ad-hoc (Peer to Peer)
	Models	Infrastructure (Access Point Required)
	Roaming	IEEE 802.11 compliant roaming between access points
	Output Power ²	• 802.11b: +18.5dBm minimum
		• 802.11g: +17.5dBm minimum
		• 802.11a: +18.5dBm minimum
		• 802.11n HT20(2.4GHz): +15.5dBm minimum
		• 802.11n HT40(2.4GHz): +14.5dBm minimum
		• 802.11n HT20(5GHz): +15.5dBm minimum
		• 802.11n HT40(5GHz): +14.5dBm minimum
		• 802.11ac VHT80(5GHz): +11.5dBm minimum



Power Consumption	 Transmit mode: 2.0 W Receive mode:1.6 W Idle mode (PSP) 180 m Idle mode: 50 mW (WL/ Connected Standby/Mc Radio disabled: 8 mW 	AN unassociated)
Power Management	ACPI and PCI Express cor 802.11 compliant power	npliant power management saving mode
Receiver Sensitivity ⁴	 802.11b, 1Mbps: -93.5 802.11b, 11Mbps: -840 802.11a/g, 6Mbps: -86 802.11a/g, 54Mbps: -7 802.11n, MCS07: -67df 802.11n, MCS15: -64df 802.11ac, MCS0: -84df 802.11ac, MCS9: -59df 	IBm maximum dBm maximum 2dBm maximum 3m maximum 3m maximum 8m maximum
Antenna type	enclosure Two embedded dual ban	with spatial diversity, mounted in the display d 2.4/5 GHz antennas are provided to the card to nmunications and Bluetooth communications
Form Factor	PCI-Express M.2 MiniCar	d
Dimensions	1. Type 2230: 2.3 x 22.0 x 30.0 mm 2. Type 1216: 1.67 x 12.0 x 16.0 mm	
Weight	1. Type 2230: 2.8 g 2. Type 126: 1.3 g	
Operating Voltage	3.3v +/- 9%	
Temperature	Operating Non-operating	14° to 158° F (–10° to 70° C) –40° to 176° F (–40° to 80° C)
Humidity	Operating Non-operating	10% to 90% (non-condensing) 5% to 95% (non-condensing)
Altitude	Operating Non-operating	0 to 10,000 ft (3,048 m) 0 to 50,000 ft (15,240 m)
LED Activity	LED Amber – Radio OFF LED Off – Radio ON	

HP Integrated Module with Bluetooth 4.0/4.1/4.2/5.0/5.0 Wireless Technology

Bluetooth Specification	4.0/4.1/4.2/5.0 Compliant
Frequency Band	2402 to 2480 MHz
Number of Available Channels	Legacy: 0~79 (1 MHz/CH) BLE: 0~39 (2 MHz/CH)



Signaling Data Rate	Legacy: 3 Mbps signaling data rate ⁵ throughput up to2.17 Mbps BLE: 1 Mbps signaling data rate ¹ throughput up to 0.2 Mbps 5. Actual throughput may vary.
	Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice channels Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)
Transmit Power	The Bluetooth component shall operate as a Class II Bluetooth device with a maximum transmit power of + 4 dBm for BR and EDR.

1. Wireless access point and internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 5 (802.11 ac) is backwards compatible with prior 802.11 specs.

2. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.

3. Check latest software/driver release for updates on supported security features.

4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).



Intel® XMM™ 7360 LTE- Advanced ¹	Technology/Operating bands	FDD LTE: LTE: 2100 (Band 1), 1900 (Band 2), 1800 (Band 3), 1700 (Band 4), 850 (Band 5), 2600 (Band 7), 900 (Band 8), 1400 (Band 11), 700 (Band 12), 700 (Band 13) 700 (Band 17), 850 (Band 18), 850 (Band 19), 800 (Band 20), 1450 (Band 21), 850 (Band 26) 700 (Band 28) MHz, 700 (Band 29), 2300 (Band 30), 2100 (Band 66) MHz TDD LTE: 2600 (Band 38), 1900 (Band 39), 2300 (Band 40), 2500 (Band 41) MHz HSPA+: 2100 (Band 1), 1900 (Band 2), 1700 (Band 4), 850 (Band 5), 900 (Band 8) MHz
	Wireless protocol standards	3GPP Release 11 LTE Specification CAT.9, MAX 60MHz aggregation BW WCDMA R99, 3GPP Release 5, 6, 7 and 8 UMTS Specification
	GPS	Standalone, A-GPS (MS-B and LTO)
	GPS bands	GPS 1575.42 MHz ± 1.023 MHz, GLONASS 1596-1607MHz, Beidou 1561.098 ± 2.046 MHz
	Maximum data rates	LTE: 450 Mbps (DL 3CA), 50 Mbps (Upload) DC-HSPA+: 42 Mbps (Download), 5.76 Mbps (Upload) HSPA+: 21Mbps (Download), 5.76 Mbps (Upload)
	Maximum output power	LTE: 23 dBm HSPA+: 23.5 dBm
	Maximum power consumption	LTE: 1,200 mA (peak); 900 mA (average) HSPA+: 1,100 mA (peak); 800 mA (average)
	Form Factor	М.2, 3042-53 Кеу В
	Weight	6 g
	Dimensions (Length x Width x Thickness)	42 x 30 x 2.3 mm

1. WWAN module is an optional feature, requires factory configuration and requires separately purchased service contract. Check with service provider for coverage and availability in your area. Connection speeds will vary due to location, environment, network conditions, and other factors. 4G LTE not available on all products, in all regions.



POWER

AC Adapter 45 Watt Smart	Dimensions	95 x 45 x 26.8 mm	
nPFC Standard Barrel 4.5mm Right Angle 1m	Weight	200 g +/- 10 g	
	Input	Input Efficiency	87.74 % at 115 Vac and 88.4 % at 230Vac
		Input frequency range	47 ~ 63 Hz
		Input AC current	Max. 1.4 A at 90 Vac
	Output	Output power	45 W
		DC output	19.5 V
		Hold-up time	5 ms at 115 Vac input
		Output current limit	<8.0A
	Connector	4.5mm Barrel Type	
	Environmental Design	Operating temperature	32°F to 95°F (0°to 35°C)
		Non-operating (storage) temperature	-4°F to 185°F (-20°to 85°C)
		Altitude	0 to 16,400 ft (0 to 5000m)
		Humidity	20% to 95%
		Storage Humidity	10% to 95%
	EMI and Safety Certifications	Worldwide safety standar SELV; Agency approvals – FCC Class B, CISPR22 Class	with LVD and EMC directives ds - IEC60950, EN60950, UL60950, Class1, C-UL-US, NORDICS, DENAN, EN55022 Class B, 5 B, CCC, NOM-1 NYCE. s at 25°C ambient condition.

AC Adapter 45 Watt Smart	Dimensions	95 x 45 x 26.8 mm	
nPFC Standard Barrel 4.5mm Right Angle 1m	Weight	Att200 g +/- 10 gInput Efficiency87.74 % at 115 Vac and 88.4 % at 230VacInput frequency range47 ~ 63 HzInput AC currentMax. 1.4 A at 90 VACOutput power45 WDC output19.5 VHold-up time5 ms at 115 Vac inputOutput current limit<8.0Aector0.4.5mm Barrel Typeonmental DesignOperating temperature AltitudeNon-operating (storage) temperature-4°F to 185°F (-20°to 85°C) 	
2prong	Input	Input Efficiency	87.74 % at 115 Vac and 88.4 % at 230Vac
		Input frequency range	47 ~ 63 Hz
		Input AC current	Max. 1.4 A at 90 VAC
	Output	Output power	45 W
		DC output	19.5 V
		Hold-up time	5 ms at 115 Vac input
		Output current limit	<8.0A
	Connector	4.5mm Barrel Type	
	Environmental Design	• •	32°F to 95°F (0°to 35°C)
			-4°F to 185°F (-20°to 85°C)
		Altitude	0 to 16,400 ft (0 to 5000m)
		Humidity	20% to 95%
		Storage Humidity	10% to 95%
	EMI and Safety Certifications	Worldwide safety standard SELV; Agency approvals – (FCC Class B, CISPR22 Class	ds - IEC60950, EN60950, UL60950, Class1, C-UL-US, NORDICS, DENAN, EN55022 Class B,

AC Adapter 65 Watt Smart nPFC Standard Barrel 4.5mm Right Angle 1m	Dimensions (H x W x D) Weight Input	90 x 51 x 28.5mm 230g +/-10% Input Efficiency Input frequency range Input AC current	88.0 % at 115 Vac and 89.0 % at 230 Vac 47 ~ 63 Hz Max. 1.7 A at 90 Vac
	Output	Output power	65W
		DC output	19.5V
		Hold-up time	5 ms at 115 Vac input
		Output current limit	<11.0A
	Connector	4.5mm Barrel Type	
	Environmental Design	Operating temperature	32°F to 95°F (0° to 35°C)
		Non-operating (storage) temperature	-4°F to 185°F (-20° to 85°C)
		Altitude	0 to 16,400 ft (0 to 5,000 m)
		Humidity	20% to 95%
		Storage Humidity	10% to 95%
	EMI and Safety Certifications	Worldwide safety standar SELV; Agency approvals - FCC Class B, CISPR22 Class	with LVD and EMC directives ds - IEC60950, EN60950, UL60950, Class1, C-UL-US, NORDICS, DENAN, EN55022 Class B, B, CCC, NOM-1 NYCE. s at 25°C ambient condition.

AC Adapter 65 Watt Smart	t Dimensions (H x W x D)	102 x 55 x 30mm	
nPFC EM Barrel 4.5mm New EM	Weight	250g +/-10%	
	Input	Input Efficiency	88.0 % at 115 Vac and 89.0 % at 230 Vac
		Input frequency range	47 ~ 63 Hz
		Input AC current	Max. 1.7 A at 90 Vac
	Output	Output power	65W
		DC output	19.5V
		Hold-up time	5 ms at 115 Vac input
		Output current limit	<11.0A
	Connector	4.5mm Barrel Type	
	Environmental Design	Operating temperature	32°F to 95°F (0° to 35°C)
		Non-operating (storage) temperature	-4°F to 185°F (-20° to 85°C)
		Altitude	0 to 16,400 ft (0 to 5,000 m)
		Humidity	20% to 95%
		Storage Humidity	10% to 95%
	Certifications	SELV; Agency approvals - FCC Class B, CISPR22 Class	ds - IEC60950, EN60950, UL60950, Class1, C-UL-US, NORDICS, DENAN, EN55022 Class B, s B, CCC, NOM-1 NYCE. rs at 25°C ambient condition.
AC Adapter 45 Watt nPFC	Dimensions (H x W x D)	94.0 x 40.0 x 26.5 mm	
Standard USB Type-C® Straight 1m	Weight	192.5g +/-10%	
Straight fin	Input	Input Efficiency	Average Efficiency of 25%, 50%, 75%, 100% load condition with 115Vac/230Vac Spec: 5V: 81.5% 9V: 86.7% 12V: 87.41% 15V: 87.8%
		Input frequency range	47 ~ 63 Hz
		Input AC current	Max. 1.4 A at 90 Vac
	Output	Output power DC output Hold-up time	5V/15W 9V/27W 12V/36W 15V/45W 5V/9V/12V/15V 5 ms at 115 Vac input
		2 	



	Connector	USB Type-C®	
	Environmental Design	Operating temperature	32°F to 95°F (0° to 35°C)
		-	-4°F to 185°F (-20° to 85°C)
		Altitude	0 to 16,400 ft (0 to 5,000 m)
		Humidity	20% to 95%
		Storage Humidity	10% to 95%
	EMI and Safety Certifications	Worldwide safety standard SELV; Agency approvals - (FCC Class B, CISPR22 Class	with LVD and EMC directives ds - IEC60950, EN60950, UL60950, Class1, C-UL-US, NORDICS, DENAN, EN55022 Class B, B, CCC, NOM-1 NYCE. s at 25°C ambient condition.
AC Adapter 65 Watt nPFC	Dimensions	90.0 x 51 x 28.5mm	
Standard USB type C® Straight 1m	Weight	250 g +/- 10 g	
Straight fin	Input	Input Efficiency	81.5% min at 115 Vac/ 230Vac @ 5V/3A 86.7% min at 115 Vac/ 230Vac @ 9V/3A 88% min at 115 Vac/ 230Vac @ 12V/5A 89% min at 115 Vac/ 230Vac @ 15V/4.33A 89% min at 115 Vac/ 230Vac @ 20V/3.25A
		Input frequency range	47 ~ 63 Hz
		Input AC current	1.6 A at 90 VAC and maximum load
	Output	Output power	65 W
		DC output	5V/9V/12V/15V/20V
		Hold-up time	5 ms at 115 Vac input
		Output current limit	8.0A Max.
	Connector	USB Type C [®]	
	Environmental Design	Operating temperature	32°F to 95°F (0°to 35°C)
		Non-operating (storage) temperature	-4°F to 185°F (-20°to 85°C)
		Altitude	0 to 16,400 ft (0 to 5000m)
		Humidity	20% to 95%
		Storage Humidity	10% to 95%
	EMI and Safety Certifications	Worldwide safety standard SELV; Agency approvals - (FCC Class B, CISPR22 Class	with LVD and EMC directives ds - IEC60950, EN60950, UL60950, Class1, C-UL-US, NORDICS, DENAN, EN55022 Class B, B, CCC, NOM-1 NYCE. s at 25°C ambient condition.



Battery CC 3 Cell 53 Wh	Dimensions (H x W x L)	7.3 x 52.9 x 267.11mm (0.287 x 2.082 x 10.516 inch)
Long Life -PL Fast Charge	Weight	0.205kg (0.45 lb)
	Cells/Type	3cell Lithium-Ion Polymer cell / 645180
	Voltage	11.55V
	Amp-hour capacity	4.59Ah
	Watt-hour capacity	53 Wh
	Temperature	32° to 113° F (0° to 45° C)
	Operating (Charging)	32° to 122° F (0° to 50° C)
	Operating (Discharging)	14° to 140° F (-10° to 60° C)
	Warranty	Depends on system offering
	Optional Travel Battery Available	Νο

Battery GR 3 Cell 42 Wh Long Life -PL Fast Charge	Dimensions (H x W x L) Weight Cells/Type	5.8 x 61.5 x274.4 mm (0.228 x 2.42 x 10.80 inch) 0.168 kg (0.37 lb) 3cell Lithium-Ion Polymer cell / 485083
	Energy	
	Voltage	11.4V
	Amp-hour capacity	3.64Ah
	Watt-hour capacity	42 Wh
	Temperature	
	Operating (Charging)	32° to 113° F (0° to 45° C)
	Operating (Discharging)	14° to 122° F (-10° to 60° C) Warranty: Depends on system offering
	Fuel Gauge LED	NA

ENVIRONMENTAL DATA

ENVIRUNMENTAL DA		or is in the process of heirs	prtified to the following approvale and may be	
& declarations	This product has received or is in the process of being certified to the following approvals and may be			
a ucciai aliviis	labeled with one or more o			
	IT ECO declaration			
	US ENERGY STAR	B		
	US Federal Energy	y Management Program (FEM	Р)	
	 EPEAT^D Gold regis 	tered in the United States. Se	e http://www.epeat.net for registration	
	status in your cou	intry.		
	 TC0 8.0 			
	China Energy Con	servation Program (CECP)		
		onmental Protection Administ	tration (SEPA)	
	Taiwan Green Ma			
	Korea Eco-label			
	Japan PC Green la	hel*		
	Jupante dicenta			
Sustainable Impact	Ocean-bound plastic in (part(s))		
Specifications	• 14.12% post-consumer r			
-	External Power Supply 9	y		
	Low halogen	5% Efficiency		
	-	tod suchions are 100% sustai	nably sourced and recyclable	
	_			
		on inside box is 100% sustain	ably sourced and recyclable	
	Bulk packaging available			
System Configuration	-	•••	I Declared Noise Emissions data for the	
	Notebook model is based (on a "Typically Configured No	tebook".	
Energy Consumption (in accordance with US ENERGY STAR® test method)	115VAC 60H-	2201/00 504-	100VAC, 50Hz	
Normal Operation (Sort	115VAC, 60Hz 5.66 W	230VAC, 50Hz 5.41 W	5.68 W	
idle)	5.00 W	5.41 VV	5.00 W	
•	0.02.111	1.20.00	1.02.14	
Normal Operation (Long	0.93 W	1.28 W	1.02 W	
idle)	0.02.111	1.20.14	1.02.14	
Sleep	0.93 W	1.28 W	1.02 W	
Off	0.36 W	0.38 W	0.36 W	
	family. HP computers mar Environmental Protection family does not offer ENER	ked with the ENERGY STAR [®] L Agency (EPA) ENERGY STAR [®] RGY STAR [®] compliant configu PC featuring a hard disk drive,	mpliant product if offered within the model ogo are compliant with the applicable U.S. specifications for computers. If a model rations, then energy efficiency data listed is a high efficiency power supply, and a	
Heat Dissipation*	115VAC, 60Hz	230VAC, 50Hz	100VAC, 50Hz	
Normal Operation (Short idle)	19 BTU/hr	18 BTU/hr	19 BTU/hr	
Normal Operation (Long idle)	3 BTU/hr	4 BTU/hr	3 BTU/hr	



Sleep	3 BT	U/hr	4 BTU/hr		3 BTU/hr
Off	1 BT	U/hr	1 BTU/hr		1 BTU/hr
	*NOTE: Heat attained for	•	calculated based on t	he measured watts, ass	suming the service level is
Declared Noise		Sound Power		Sound	Pressure
Emissions		(L _{WAd} , bels)		(L _{pAm} , c	lecibels)
(in accordance with ISO 7779 and ISO 9296)					
Typically Configured – Idle		2.5 14.4			
Fixed Disk – Random writes		2.6 16.9 3.3 25.8			
Optical Drive – Sequential reads		3.3		2	5.8
Longevity and Upgrading	-		ed, possibly extendii ts contained in the	ng its useful life by seve	ral years. Upgradeable
	Spare parts a production.	are available th	roughout the warrar	nty period and or for up	to "5" years after the end of
	 This (WE This Drin This http Plas ISO 	EE) Directive – s product is in c king Water and product is in c ://www.epeat. stics parts weig 1043.	2002/96/EC. compliance with Calif d Toxic Enforcement compliance with the I .net ghing over 25 grams	ornia Proposition 65 (St Act of 1986). EEE 1680 (EPEAT) stanc	lard at the Gold level, see marked per ISO11469 and
Packaging Materials	External:	PAPER/Corr	ugated		261 g
	Internal:	PLASTIC/pol	lypropylene		3 g
	PLASTIC/Polyethylene low density	ty	14 g		
		170 g			
	The plastic packaging material contains at least 0% recycled content.				
				tains at least 54.5% rec	-
RoHS Compliance	restrictions i products wo legislation in	n the Europear rldwide throug Europe, as we	n Union (EU) Restricti Ih the HP GSE. HP has Ill as China, India, and	on of Hazardous Substa contributed to the deve Vietnam.	
	elimination o	of substances o C, BFRs, and ce	of concern. We have s	supported the inclusion	n promoting industry-wide of additional substances— I that pertains to electrical



	We met our voluntary objective to achieve worldwide compliance with the new EU RoHS
	requirements for virtually all relevant products by July 2013, and we will continue to extend the
	scope of the commitment to include further restricted substances as regulations continue to evolve.
	To obtain a copy of the HP RoHS Compliance Statement, see HP RoHS position statement.
Material Usage	This product does not contain any of the following substances in excess of regulatory limits (refer to
	the HP General Specification for the Environment at
	http://www.hp.com/hpinfo/globalcitizenship/environment/supplychain/gen_specifications.html):
	Asbestos
	Certain Azo Colorants
	Certain Brominated Flame Retardants – may not be used as flame retardants in plastics
	Cadmium
	Chlorinated Hydrocarbons
	Chlorinated Paraffins
	Bis(2-Ethylhexyl) phthalate (DEHP)
	Benzyl butyl phthalate (BBP)
	Dibutyl phthalate (DBP)
	Diisobutyl phthalate (DIBP)
	Formaldehyde
	Halogenated Diphenyl Methanes
	Lead carbonates and sulfates
	Lead and Lead compounds
	Mercuric Oxide Batteries
	Nickel – finishes must not be used on the external surface designed to be frequently
	handled or carried by the user.
	Ozone Depleting Substances
	Polybrominated Biphenyls (PBBs)
	Polybrominated Biphenyl Ethers (PBBEs)
	Polybrominated Biphenyl Oxides (PBBOs)
	Polychlorinated Biphenyl (PCB)
	Polychlorinated Terphenyls (PCT)
	• Polyvinyl Chloride (PVC) – except for wires and cables, and certain retail packaging has been
	voluntarily removed from most applications.
	Radioactive Substances Triter (TDT) Triter (TDT)
	• Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)
Packaging Usage	HP follows these guidelines to decrease the environmental impact of product packaging:
	• Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in
	packaging materials.
	Eliminate the use of ozone-depleting substances (ODS) in packaging materials.
	Design packaging materials for ease of disassembly.
	Maximize the use of post-consumer recycled content materials in packaging materials.
	Use readily recyclable packaging materials such as paper and corrugated materials.
	 Reduce size and weight of packages to improve transportation fuel efficiency.
	Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.



End-of-life Management and Recycling	HP offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: http://www.hp.com/go/reuse-recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner. The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: http://www.hp.com/go/recyclers. These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.
HP, Inc. Corporate Environmental Information	For more information about HP's commitment to the environment: Global Citizenship Report http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html Eco-label certifications http://www8.hp.com/us/en/hp-information/environment/ecolabels.html ISO 14001 certificates: http://h20195.www2.hp.com/V2/GetDocument.aspx?docname=c04755842 and http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf
footnotes	 Percentage of ocean-bound plastic contained in each component varies by product Recycled plastic content percentage is based on the definition set in the IEEE 1680.1-2018 standard. External power supplies, WWAN modules, power cords, cables and peripherals excluded. 100% outer box packaging and corrugated cushions made from sustainably sourced certified and recycled fibers. Fiber cushions made from 100% recycled wood fiber and organic materials.

FINGERPRINT READER

Model	Synaptics Validity VFS7604 touch sensor
Mobile Voltage Operation	3.0V to 3.6V
Operating Temperature:	0~60°C
Current Consumption Image:	100mA Max
Low Latency Wait For Finger	260 uA
Capture Rate: Image transmitter output frequency	9.6MHz
ESD Resistance	IEC 61000-4-2 4B (+/-15KV)
Detection Matrix	363 dpi / 7.4x6mm sensor area
FRR (False Reject Rate) / FAR (False Acceptance Rate)	FRR <1% @ 1:50K FAR



Country of Origin

China



QuickSpecs

Options and Accessories (sold separately and availability may vary by country)

Туре	Description	Part Number
Cases	HP Prelude Pro Top Load	1X645AA
	HP Prelude Pro Backpack	1X644AA
Docking	HP USB-C Mini Dock	1PM64AA
	HP USB-C Travel Dock G2	7PJ38AA
Input/Output	HP WL USB Agnes Keyboard	T6U20AA
	HP Slim Wireless Keyboard and Mouse	T6L04AA
	HP Wireless USB Premium Keyboard	Z9N41AA
	HP Wireless Rechargeable 950MK Mouse and Keyboard	3M165AA
	HP 235 WL Mouse and Keyboard Combo	1Y4D0AA
	HP Wired Desktop 320MK Mouse and Keyboard	9SR36AA
	HP Wired Desktop 320K Keyboard	9SR37AA
	HP Wired Desktop 320M Mouse	9VA80AA
	HP 125 Wired Keyboard	266C9AA
	HP 225 Wired Mouse and Keyboard Combo	286J4AA
	HP Wired Mouse	265A9AA
	HP LSR Wired Mouse	265D9AA
	HP Bluetooth Travel Bluetooth Mouse	6SP30AA
	HP Comfort Grip USB Wireless Mouse	H2L63UT
	HP Creator USB-A+Bluetooth 935 Wireless Mouse Black	1D0K8AA
	HP USB Travel USB Mouse	G1K28AA
	HP USB-A+Bluetooth Multi-Device 635 Wireless Mouse Black	1D0K2AA
	HP X4000b Bluetooth Mouse	НЗТ50АА
	HP Wireless Premium Mouse	1JR31AA
	HP USB Premium Mouse	1JR32AA
	HP USB Fingerprint Mouse	4TS44AA
	HP Elite Presenter Mouse	2CE30AA
	HP HDMI to DVI Adapter	F5A28AA
	HP HDMI to VGA Adapter	H4F02AA
	HP USB-C to DisplayPort Adapter	N9K78AA
	HP USB-C to HDMI 2.0 Adapter	1WC36AA
	HP USB-C to RJ45 Adapter	V7W66AA
	HP USB-C to USB-A Hub	Z6A00AA
	HP USB-C to VGA Adapter	N9K76AA
	HP USB to Gig RJ45 Adapter	N7P47AA
Power	HP 45W Smart AC Adapter 4.5mm	H6Y88AA
	HP 45W Smart Power Adapter 2 prong -4.5mm (Japan only)	L6F60AA



QuickSpecs

Options and Accessories (sold separately and availability may vary by country)

	HP 65W Smart Power Adapter (w/ 4.5mm to 7.5mm DC dongle)	H6Y89AA
	HP 65W Slim AC Adapter	H6Y82AA
	HP 65W USB-C Slim Power Adapter	3PN48AA
	HP 45W USB-C LC Dali AC Power Adapter	1MZ01AA
	HP USB-C Essential Power Bank	3TB55AA
Storage	HP External USB Optical Drive	F2B56AA
Memory	HP 4GB DDR4 3200 Memory	286H5AA
i iciiioi y	HP 8GB DDR4 3200 Memory	286H8AA
	HP 16GB DDR4 3200 Memory	286J1AA
Convitu		CU11/4744
Security	HP Sure Key Cable Lock	6UW42AA
	HP Nano Keyed Cable Lock	1AJ39AA



Summary of Changes

Date of change:	Version History:		Description of change:
April 20, 2021	V1 to V2	Updated	Memory Section and Input/ Output Section Updated
April 26, 2021	V2 to V3	Updated	BIOS information in Software section/Environmental Data
May 6, 2021	V3 to V4	Added	HP Smart Support
May 11, 2021	V4 to V5	Updated	Product Dimensions
May 27, 2021	V5 to V6	Update	HP Pro Security Edition to HP Wolf Pro Security Edition
June 11, 2021	V6 to V7	Removed	HP WorkWell from Software and Security Section

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